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LH52256CD-70LL

256K SRAM

(Model No.: LH525C7D)

Spec No.: EL093115

Issue Date: March 25, 1997

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- When using the products covered herein, please observe the conditions written herein and the precautions outlined in the following paragraphs. In no event shall the company be liable for any damages resulting from failure to strictly adhere to these conditions and precautions.
 - (1) The products covered herein are designed and manufactured for the following application areas. When using the products covered herein for the equipment listed in Paragraph (2), even for the following application areas, be sure to observe the precautions given in Paragraph (2). Never use the products for the equipment listed in Paragraph (3).
 - Office electronics
 - Instrumentation and measuring equipment
 - Machine tools
 - Audiovisual equipment
 - Home appliances
 - Communication equipment other than for trunk lines

 - (2) Those contemplating using the products covered herein for the following equipment which demands high reliability, should first contact a sales representative of the company and then accept responsibility for incorporating into the design fail-safe operation, redundancy, and other appropriate measures for ensuring reliability and safety of the equipment and the overall system.
 - Control and safety devices for airplanes, trains, automobiles, and other transportation equipment
 - Mainframe computers
 - Traffic control systems
 - Gas leak detectors and automatic cutoff devices
 - Rescue and security equipment
 - Other safety devices and safety equipment, etc.

 - (3) Do not use the products covered herein for the following equipment which demands extremely high performance in terms of functionality, reliability, or accuracy.
 - Aerospace equipment
 - Communications equipment for trunk lines
 - Control equipment for the nuclear power industry
 - Medical equipment related to life support, etc.

 - (4) Please direct all queries and comments regarding the interpretation of the above three Paragraphs to a sales representative of the company.

- Please direct all queries regarding the products covered herein to a sales representative of the company.

Contents

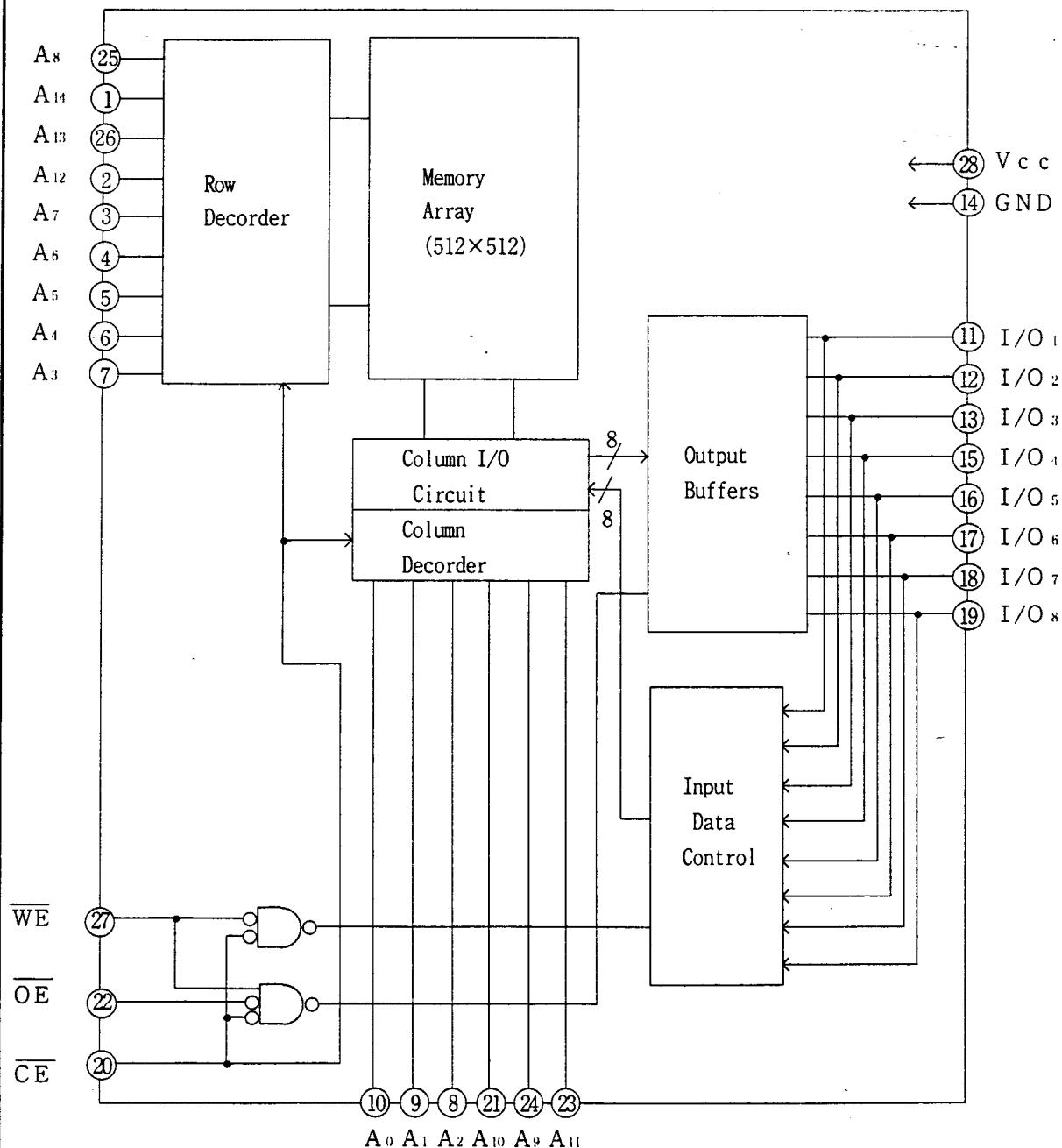
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3. Truth Table

\overline{CE}	\overline{WE}	\overline{OE}	Mode	I/O ₁ to I/O ₈	Supply current
H	*	*	Standby	High impedance	Standby (I _{SB})
L	H	L	Read	Data output	Active (I _{CC})
L	H	H	Output disable	High impedance	Active (I _{CC})
L	L	*	Write	Data Input	Active (I _{CC})

(* = Don't Care, L=Low, H=High)

4. Block Diagram



5. Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Supply voltage (*1)	V_{CC}	-0.5 to +7.0	V
Input voltage (*1)	V_{IN}	-0.5 (*2) to $V_{CC}+0.5$	V
Operating temperature	T_{OPR}	0 to +70	°C
Storage temperature	T_{STG}	-65 to +150	°C

Note) *1. The maximum applicable voltage on any pin with respect to GND.

*2. Undershoot of -3.0V is allowed width of pluse below 50ns.

6. Recommended DC Operating Conditions

($T_a = 0^\circ\text{C}$ to $+70^\circ\text{C}$)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V_{CC}	4.5	5.0	5.5	V
Input voltage	V_{IH}	2.2		$V_{CC}+0.5$	V
	V_{IL}	-0.5 (*3)		0.8	V

Note) *3. Undershoot of -3.0V is allowed width of pluse below 50ns.

7. DC Electrical Characteristics

($T_a = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{CC} = 4.5\text{V}$ to 5.5V)

Parameter	Symbol	Conditions	Min.	Typ. (*4)	Max.	Unit
Input leakage current	I_{LI}	$V_{IN} = 0\text{V}$ to V_{CC}	-1.0		1.0	μA
Output leakage current	I_{LO}	$\overline{CE} = V_{IH}$ or $\overline{OE} = V_{IH}$ $V_{I/O} = 0\text{V}$ to V_{CC}	-1.0		1.0	μA
Operating supply current	I_{CC}	Minimum cycle $V_{IN} = V_{IL}$ or V_{IH} , $I_{I/O} = 0\text{mA}$, $\overline{CE} = V_{IL}$		2.5	4.5	mA
	I_{CC1}	$t_{rc}, t_{fc} = 1\mu\text{s}$ $V_{IN} = V_{IL}$ or V_{IH} , $I_{I/O} = 0\text{mA}$, $\overline{CE} = V_{IL}$			1.0	mA
Standby current	I_{SB}	$\overline{CE} \geq V_{CC} - 0.2\text{V}$		0.6	4.0	μA
	I_{SB1}	$\overline{CE} = V_{IH}$			3	mA
Output voltage	V_{OL}	$I_{OL} = 2.1\text{mA}$			0.4	V
	V_{OH}	$I_{OH} = -1.0\text{mA}$	2.4			V

Note) *4. Typical values at $V_{CC} = 5.0\text{V}$, $T_a = 25^\circ\text{C}$.

8. AC Electrical Characteristics

AC Test Conditions

Input pulse level	0.6 V to 2.4 V
Input rise and fall time	10 ns
Input and Output timing Ref. level	1.5 V
Output load	1 TTL + C _L (100 pF) (*5)

Note) *5. Including scope and jig capacitance.

Read cycle

(T_a = 0°C to +70°C, V_{cc} = 4.5 V to 5.5 V)

Parameter	Symbol	Min.	Max.	Unit	
Read cycle time	t _{RC}	70		ns	
Address access time	t _{AA}		70	ns	
CE access time	t _{ACE}		70	ns	
Output enable to output valid	t _{OE}		35	ns	
Output hold from address change	t _{OH}	10		ns	
CE Low to output active	t _{LZ}	10		ns	*6
OE Low to output active	t _{OLZ}	5		ns	*6
CE High to output in High impedance	t _{HZ}	0	30	ns	*6
OE High to output in High impedance	t _{OHZ}	0	30	ns	*6

Write cycle

(T_a = 0°C to +70°C, V_{cc} = 4.5 V to 5.5 V)

Parameter	Symbol	Min.	Max.	Unit	
Write cycle time	t _{WC}	70		ns	
CE Low to end of write	t _{CW}	45		ns	
Address valid to end of write	t _{AW}	45		ns	
Address setup time	t _{AS}	0		ns	
Write pulse width	t _{WP}	35		ns	
Write recovery time	t _{WR}	0		ns	
Input data setup time	t _{DW}	30		ns	
Input data hold time	t _{DH}	0		ns	
WE High to output active	t _{OW}	5		ns	*6
WE Low to output in High impedance	t _{WZ}	0	30	ns	*6
OE High to output in High impedance	t _{OHZ}	0	30	ns	*6

Note) *6. Active output to High impedance and High impedance to output active tests specified for a ±200mV transition from steady state levels into the test load.

9. Data Retention Characteristics

(Ta= 0°C to +70°C)

Parameter	Symbol	Conditions	Min.	Typ. (*7)	Max.	Unit
Data Retention supply voltage	V _{CCDR}	$\overline{CE} \geq V_{CCDR} - 0.2V$	2.0		5.5	V
Data Retention supply current	I _{CCDR}	V _{CCDR} = 3V	Ta = 25°C	0.3	1.0	μA
			Ta = 40°C		3.0	μA
		$\overline{CE} \geq V_{CCDR} - 0.2V$			15	μA
Chip enable setup time	t _{CDR}		0			ns
Chip enable hold time	t _R		(*8) t _{RC}			ns

Note) *7. Typical values at Ta=25°C

*8. Read Cycle

10. Pin Capacitance

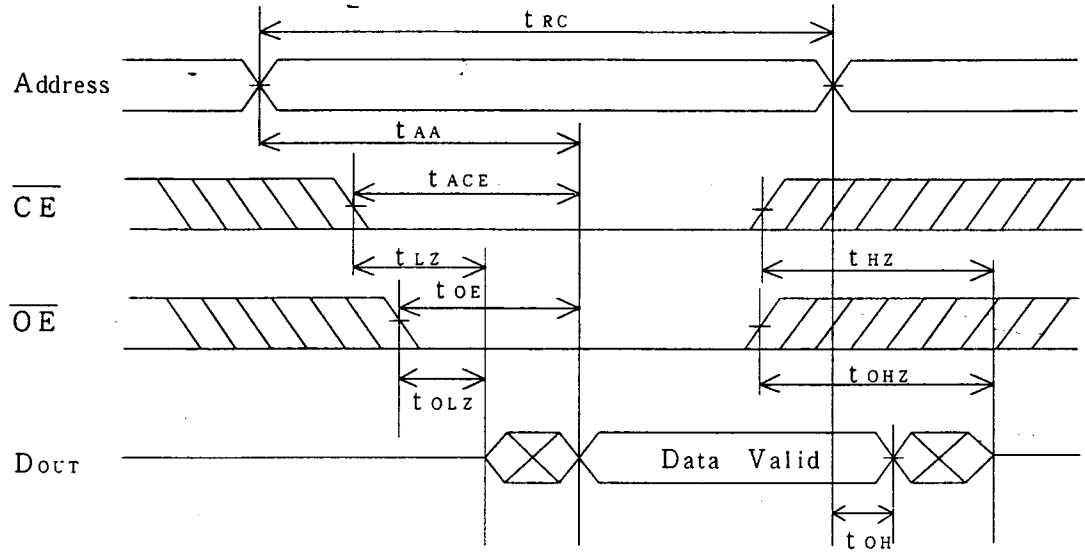
(Ta= 25°C, f = 1MHz)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Input capacitance	C _{IN}	V _{IN} = 0V			7	pF *9
I/O capacitance	C _{I/O}	V _{I/O} = 0V			10	pF *9

Note) *9. This parameter is sampled and not production tested.

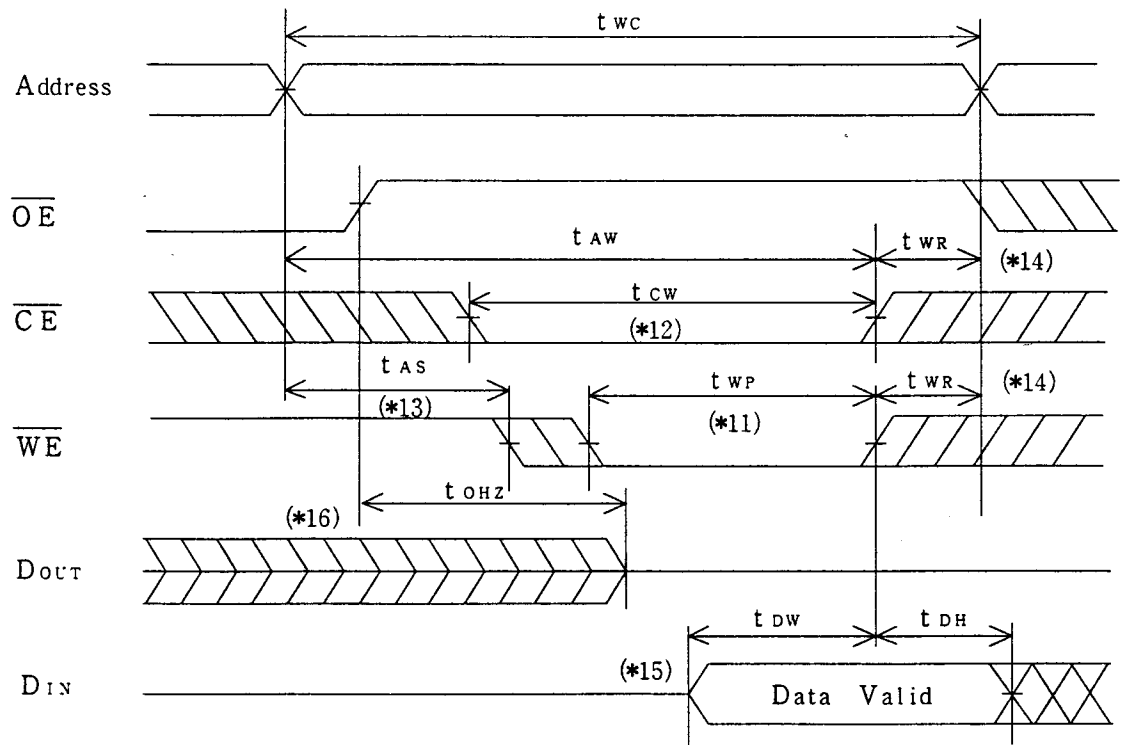
11. Timing Chart

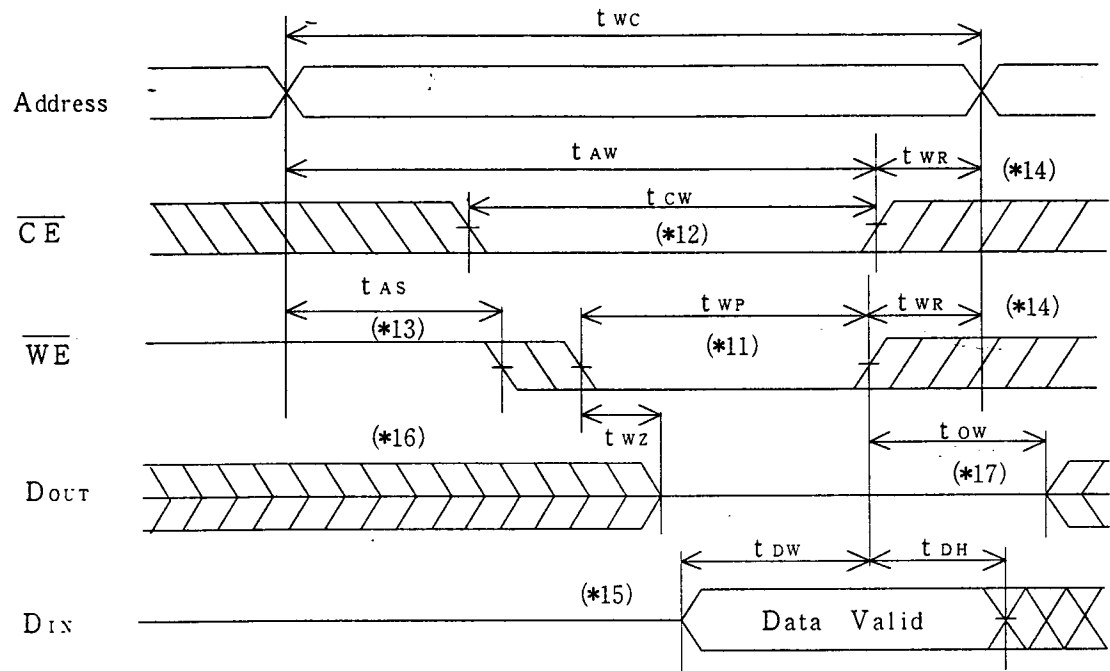
Read cycle timing chart - (*10)



Note) *10. \overline{WE} is high for Read cycle.

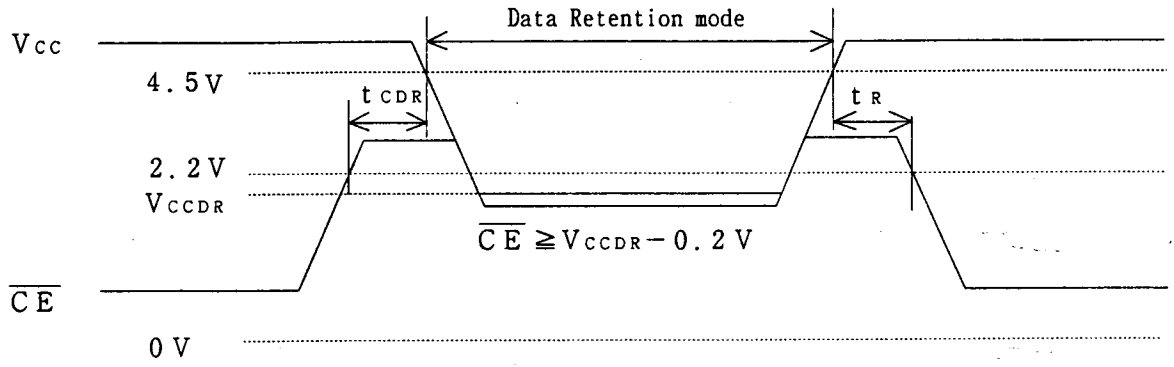
Write cycle timing chart - (\overline{OE} Controlled)



Write cycle timing chart — (\overline{OE} Low fixed)

- Note) * 11. A write occurs during the overlap of a low \overline{CE} , and a low \overline{WE} .
 A write begins at the latest transition among \overline{CE} going low, and \overline{WE} going low.
 A write ends at the earliest transition among \overline{CE} going high, and \overline{WE} going high.
 t_{WP} is measured from the beginning of write to the end of write.
- * 12. t_{cw} is measured from the later of \overline{CE} going low to the end of write.
- * 13. t_{AS} is measured from the address valid to the beginning of write.
- * 14. t_{WR} is measured from the end of write to the address change.
- * 15. During this period, I/O pins are in the output state, therefore the input signals of opposite phase to the outputs must not be applied.
- * 16. If \overline{CE} goes low simultaneously with \overline{WE} going low or after \overline{WE} going low, the outputs remain in high impedance state.
- * 17. If \overline{CE} goes high simultaneously with \overline{WE} going high or before \overline{WE} going high, the outputs remain in high impedance state.

Data Retention timing chart - (\overline{CE} Controlled)



12 Package and packing specification

1. Package Outline Specification

Refer to drawing No. AA 9 9 7

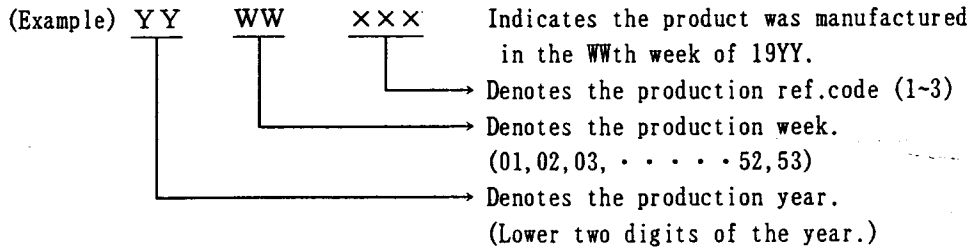
2. Markings

2-1. Marking contents

(1) Product name : LH52256CD-70LL

(2) Company name : SHARP

(3) Date code



(4) The marking of "JAPAN" indicates the country of origin.

2-2. Marking layout

Refer to drawing No. AA 9 9 7

(This layout does not define the dimensions of marking character and marking position.)

3. Packing Specification

3-1. Packing materials

Material Name	Material Specification	Purpose
Magazine	Anti-static treated plastic (14 devices/magazine)	Packing of device
Stopper	Plastic or rubber	Fixing of device
Label	Paper	Indication of product name, quantity and date of manufacture.
Inner case	Cardboard (560 devices/case)	Fixing of magazine
Outer case	Cardboard	Outer packing of magazine

(Devices shall be inserted into a magazine (sleeve) in the same direction.)

3-2. Outline dimension of magazine (sleeve)

Refer to attached drawing.

4. Precaution For Unpacking

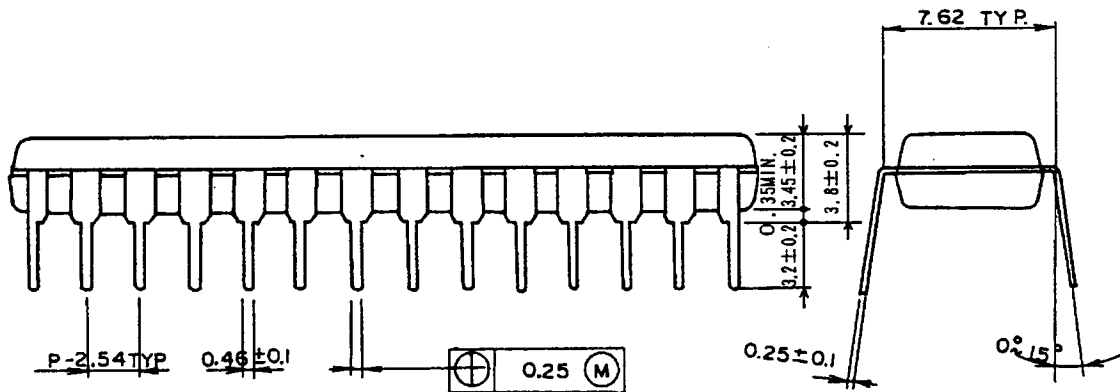
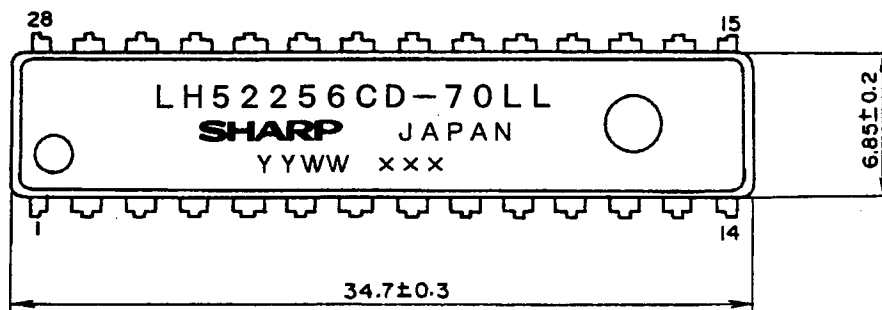
- (1) Unpacking should be done on the stand as well as human body treated with anti-ESD.
- (2) Anti-ESD treatment is given to a magazine.
Use the equivalent magazine, if it is changed to another one.
- (3) Be sure to fix two stoppers to both ends of a magazine when storage to prevent the devices from slipping.

5. Surface Mount Conditions

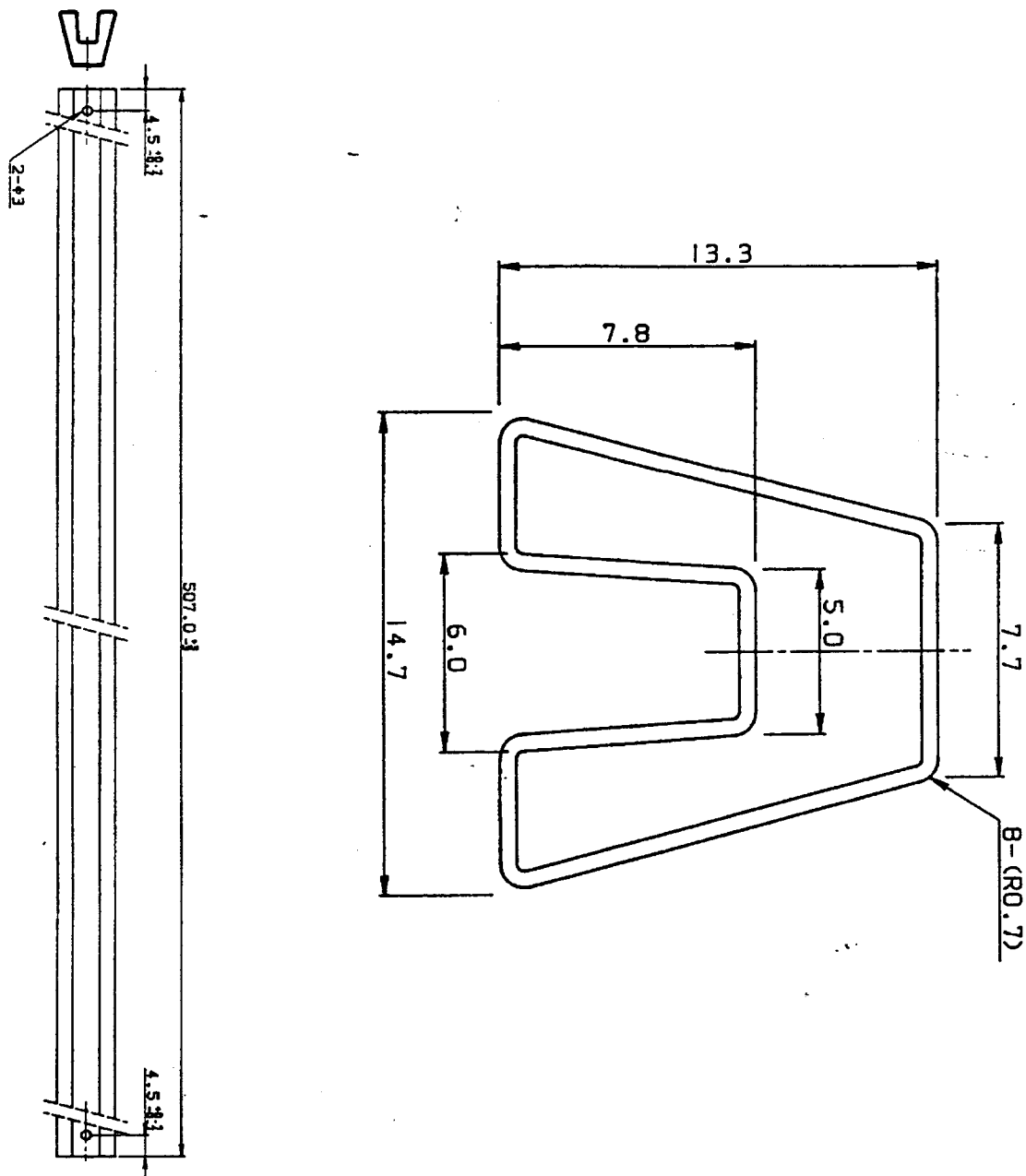
Please perform the following conditions when mounting ICs not to deteriorate IC quality.

5-1. Soldering conditions (The following conditions are valid only for one time soldering.)

Mounting Method	Temperature and Duration	Measurement Point
Solder dipping	245°C or less, duration of less than 3 seconds/dip, total of 5 seconds. (Only the appropriate parts of leads for soldering are immersed in the surface of a jet stream solder bath. During soldering, the solder stream must not come into direct contact with the plastic body of package.)	Solder bath.
Manual soldering (soldering iron)	260°C or less, duration of less than 10 seconds. (Only the appropriate parts of leads for soldering are soldered with a soldering iron. During soldering, the soldering iron must not come into direct contact with the plastic body of package.)	IC outer lead surface.



名称 NAME	DIP28-P-300	リード仕上 LEAD FINISH	TIN-LEAD PLATING	備考 NOTE	プラスチックパッケージ形状は、バリを含まないものとする。 Plastic body dimensions do not include burr of resin.
DRAWING NO.	AA997	単位 UNIT	mm		



注記 : 片側ピンストッパー, 片側ゴムストッパーとする。

指示無き寸法公差は全て±0.4とする。

NOTES : One end of magazine (sleeve) is plugged by stopper which is made of rubber, and another end of magazine (sleeve) is plugged by plastic pin-stopper.

All tolerances are ±0.4mm unless otherwise specified

名称 NAME	DP300SPB			備考 NOTE
DRAWING NO.	CV503	単位 UNIT	mm	

Static, SRAM, RAM, Random Access Memory, LH52256CD-70LL